# Thermal shock fracture behaviour of ZrO<sub>2</sub> based ceramics

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Thermal shock fracture behaviour of alumina, mullite, silicon carbide, silicon nitride and various kinds of zirconia based ceramics, such as magnesia partially stabilized zirconia (Mg-PSZ), yttria and ceria doped tetragonal zirconia polycrystals (Y-TZP and Ce-TZP), Y-TZP/Al<sub>2</sub>O<sub>3</sub> composites and yttria doped cubic stabilized zirconia (Y-CSZ), was evaluated by the quenching method using water, methyl alcohol and glycerin as quenching media. Thermal shock fracture of all materials seemed to proceed by the thermal stress due to convective heat transfer accompanied by boiling of the solvents under the present experimental conditions. Thermal shock resistance of zirconia based ceramics increased with increasing the fracture strength, but that of Y-TZP and Y-TZP/Al<sub>2</sub>O<sub>3</sub> composites was anormalously lower than the predicted value.

## 1. Introduction

Since ceramic materials show excellent thermal stability and high temperature fracture strength, they have been leading candidates for high temperature structural applications. Thermal shock resistance of ceramic materials is one of the most important properties, because brittle ceramics are susceptible to catastrophic failure under conditions of thermal stress introduced by the temperature difference.

Many studies have been carried out to elucidate the basic principles governing the thermal stress fracture of brittle ceramics. The quenching test into liquid media such as water, silicon oil and liquid metal has been used extensively for characterizing the thermal shock resistance of ceramics [1-3], because this test is relatively simple to provide quantitative thermal shock resistance, e.g. a critical quenching temperature difference,  $\Delta T_{\rm c}$ , required the initiation of thermal stress fracture. It was reported [4] that the observed thermal shock resistance was generally in good agreement to the predicted value by the thermal shock resistance parameter,  $R = \sigma_{\rm f}(1 - \nu)/\alpha E$ , where  $\sigma_{\rm f}$ is the fracture strength, v is Poisson's ratio,  $\alpha$  is the linear thermal expansion coefficient and E is Young's modulus.

Since zirconia based ceramics such as Y-TZP show extensively high fracture strength and toughness such as 800-2500 MPa and 7-10 MPa m<sup>1/2</sup> [5, 6] due to the transformation toughening mechanism, they are expected to show excellent thermal shock resistance. However, thermal shock resistance of zirconia based ceramics were modest [7–11] and the details have not been clarified yet.

In the present paper, the thermal stress fracture behaviour of zirconia based ceramics was evaluated by the quenching method together with that of some other structural ceramics materials.

## 2. Experimental procedures

Yttria doped tetragonal zirconia powders containing 2 and 3 mol % Y<sub>2</sub>O<sub>3</sub> (2Y-TZP and 3Y-TZP), yttria doped cubic stabilized zirconia powder containing 6 mol %  $Y_2O_3$  (6Y-CSZ), ceria doped tetragonal zirconia powders containing 8, 12 and 16 mol % CeO<sub>2</sub> (8Ce-TZP, 12Ce-TZP and 16Ce-TZP), and high purity Al<sub>2</sub>O<sub>3</sub> powders were used as starting materials. 2Y-TZP and  $Al_2O_3$  powders were mixed in the desired weight ratio. These powders were isostatically pressed at 200 MPa to form plates  $(5 \text{ mm} \times 30 \text{ mm} \times 50 \text{ mm})$  and sintered at 1500°C for 3-10 h in air. The presintered samples of 2Y-TZP/Al<sub>2</sub>O<sub>3</sub> were hot isostatically pressed at 1450° C and 150 MPa for 1 h in argon atmosphere. The sintered body of mullite was fabricated by the procedures described in the previous paper [10]. The sintered bodies of Mg-PSZ, SiC and Si<sub>3</sub>N<sub>4</sub> were supplied by Nilcra Ceramics PTY Ltd, NGK Spark Plug Co., Ltd and Toshiba Co., respectively. The characteristics of the samples are summarized in Table I. The samples were cut into bars  $(5 \text{ mm} \times 2 \text{ mm} \times 15 \text{ mm})$ and polished to parallel mirror like plane. The thermal shock resistance of each specimen was determined by the quenching test using water, methyl alcohol and glycerin at 0° C as the quenching media. The bending strength ( $\sigma_{3h}$ ) of the specimen was determined by 3-point bending test with a crosshead speed of  $0.5 \,\mathrm{mm}\,\mathrm{min}^{-1}$  and span length of 10 mm.

#### 3. Results and discussion

The thermal shock fracture tests of 3Y-TZP and  $Al_2O_3$  were carried out using water, methyl alcohol and glycerin at 0° C as the quenching media. The results are shown in Figs 1 and 2. A variety of the critical temperature differences from 275 to  $475^{\circ}$  C for 3Y-TZP and 200 to  $350^{\circ}$  C for  $Al_2O_3$  were observed by using different quenching media.



Two kinds of heat transfer mechanism, i.e. conductive heat transfer and convective heat transfer, have been considered to interpret the experimental data for thermal shock resistance of ceramics obtained by the quenching test. Analysis of thermal shock resistance is simplified using a nondimensional maximum thermal stresses of  $\sigma^*$  expressed by Equation 1,

$$\sigma^* = S_t(1 - v)/\alpha E\Delta T \qquad (1)$$

where  $S_t$  and  $\Delta T$  are the thermal stress and the temperature difference, respectively. When the thermal stress equals the tensile strength,  $\sigma_t$ , of materials, the thermal stress fracture might proceed. Therefore, the critical quenching temperature difference is expressed by Equation 2.

$$\Delta T_{\rm c} = \sigma_{\rm t} (1 - v) / \alpha E \sigma^* \qquad (2)$$

 $\sigma^*$  for the convective heat transfer,  $\sigma_v^*$ , and conductive heat transfer,  $\sigma_d^*$ , can be described by Equations 3 and 4, respectively [12, 13].

$$1/\sigma_{v}^{*} = 1.451(1 + 3.42/\beta)$$
  
= 1.451(1 + 3.42k/r\_mh) (3)

$$1/\sigma_{\rm d}^* = (k_1 \varrho_1 c_1 / k_2 \varrho_2 c_2)^{1/2} + 1$$
 (4)

TABLE I Characteristics of the sintered bodies

Figure 1 Relation between 3-point bending strength of 3Y-TZP and quenching temperature difference for various quenching media.

where  $\beta$  is Biot's number,  $r_m$  is half thickness for plate sample and radius for cylinder sample, *h* is heat transfer coefficient, *k* is thermal conductivity, *c* is specific heat,  $\rho$  is density and subscripts 1 and 2 refer to the sample and quenching medium, respectively.

The nondimensional thermal stresses,  $\sigma_v^*$  and  $\sigma_d^*$  calculated from Equations 3 and 4 are listed in Table II together with the thermophysical properties of each solvent, where *h* was calculated by Holman's Equation 5 [14] by assuming natural convection.

$$h = 0.53 (Gr \cdot Pr)^{1/4} (k_2/2r_m)$$
(5)  

$$Gr = gB_2(T_1 - T_2)(2r_m)^3 \varrho_2^2/\mu_2^2$$
  

$$Pr = c_2 \mu_2/k_2$$

where Gr and Pr are Grashof number and Prandtl number, respectively, g is the gravitational constant, B is the volumetric thermal expansion coefficient and  $\mu$ is the viscosity. The quantity  $(T_1 - T_2)$  was taken to be 300° C for all calculations. As seen in Table II, for all quenching media,  $\sigma_d^*$  was greater than  $\sigma_v^*$ . The relationship between  $\Delta T_c$  and  $1/\sigma_d^*$  for 3Y-TZP and Al<sub>2</sub>O<sub>3</sub> is shown in Fig. 3. The straight lines were calculated from Equations 2 and 4, where the values of  $\sigma_t$ .

Material	$\alpha$ (× 10 <sup>-6</sup> K <sup>-1</sup> )	v	E (GPa)	k (W m <sup>-1</sup> K <sup>-1</sup> )	$\sigma_{3b}$ (MPa)	<i>R</i> <sup>*</sup> <sub>0</sub>
Al <sub>2</sub> O <sub>3</sub>	7.4	0.27	393	18.5	300	75
SiC	3.2	0.25	330	91	330	234
Si <sub>3</sub> N <sub>4</sub>	3,2	0.25	330	25	500	355
Mg-PSZ	10.1	0.23	205	1.8	460	171
6Y-CSZ	9.0	0.25	200	3:5	240	100
3Y-TZP	9.0	0.25	200	3.5	900	292
2Y-TZP	9.0	0.25	200	3.5	1300	542
2Y-TZP/10 wt % Al <sub>2</sub> O <sub>3</sub>	8.8	0.25	229	3.5*	1720	640
2Y-TZP/20 wt % Al <sub>2</sub> O <sub>3</sub>	8.6	0.26	254	5.7*	2060	698
2Y-TZP/40 wt % Al <sub>2</sub> O <sub>3</sub>	8.2	0.26	298	7.8*	2000	627
8Ce-TZP	5.2	0.25	200	3.5*	600	433
12Ce-TZP	10.9	0.25	200	3.5	425	146
16Ce-TZP	5.8	0.25	200	3.5*	160	103

 $*R_0 = \sigma_{3b}(1 - v)/\alpha E$ \*Estimated



were calculated using Equation 6 [15] by using the value of Weibull modulus, m, of 10.

$$\sigma_{t}/\sigma_{3b} = [1/2(m+1)^{2}]^{1/m}$$
(6)

As seen in Fig. 3, the experimental values were significantly smaller than the calculated ones. These results indicated that thermal shock fracture of the samples was not initiated by the thermal stress due to conductive heat transfer, but the convective heat transfer accompanied by boiling of the solvents played an important role in the thermal stress fracture under these experimental conditions. Actually, it was reported that the heat transfer coefficient under boiling condition was much greater than that under natural convection [16].

 $\Delta T_{\rm c}$  of various zirconia based ceramics, Al<sub>2</sub>O<sub>3</sub>, mullite, SiC and Si<sub>3</sub>N<sub>4</sub> determined by the quenching

Figure 2 Relation between 3-point bending strength of  $Al_2O_3$  and quenching temperature difference for various quenching media.

test into water at 0° C are listed in Table III together with 3-point bending strength,  $\sigma_{3b}$ . Since  $\sigma_{3b}$  of TZP and PSZ significantly decreased with increasing temperature, the values of  $\sigma_{3b}$  listed were high temperature 3-point bending strength [6, 17];  $\sigma_{3b}^{h}$  at 300° C for Mg-PSZ, 3Y-TZP, 2Y-TZP, 2Y-TZP/Al<sub>2</sub>O<sub>3</sub> composites and Ce-TZP, and room temperature 3-point bending strength  $\sigma_{3b}^{r}$  for Al<sub>2</sub>O<sub>3</sub>, SiC and Si<sub>3</sub>N<sub>4</sub>, where  $\sigma_{3b}^{h}$  for Ce-TZP was estimated by Equation 7.

$$\sigma_{3b}^{r}(\text{Ce-TZP})$$

$$= [\sigma_{3b}^{r}(\text{Ce-TZP})/\sigma_{3b}^{r}(2\text{Y-TZP})]\sigma_{3b}^{h}(2\text{Y-TZP}) \quad (7)$$

From Equations 1 and 2, it can be expected that the thermal shock resistance of ceramic materials is improved by increasing fracture strength and by decreasing thermal stress. The relation between  $\sigma_{3b}$ 



Figure 3 Relation between the critical temperature difference and the reciprocal of the nondimensional maximum stress for conductive heat transfer. Quenching media ( $\bigcirc$ ) Al<sub>2</sub>O<sub>3</sub> into water, ( $\triangle$ ) Al<sub>2</sub>O<sub>3</sub> into methyl alcohol, ( $\square$ ) Al<sub>2</sub>O<sub>3</sub> into glycerin, ( $\bigcirc$ ) 3Y-TZP into water, ( $\triangle$ ) 3Y-TZP into methyl alcohol, ( $\blacksquare$ ) 3Y-TZP into glycerin.  $\sigma_t = 400 \text{ MPa}$  for Y-TZP and 170 MPa for Al<sub>2</sub>O<sub>3</sub>.



Figure 4 Relation between the fracture strength and the critical water quenching temperature difference of 6Y-CSZ, Mg-PSZ, Ce-TZP, 3Y-TZP and 2Y-TZP/Al<sub>2</sub>O<sub>3</sub> composites.

and  $\Delta T_c$  for zirconia based ceramics is shown in Fig. 4.  $\Delta T_c$  linearly increased with increasing  $\sigma_{3b}$ , but these plots were divided into two groups. The slope of the straight line for 2Y-TZP, 3Y-TZP and 2Y-TZP/Al<sub>2</sub>O<sub>3</sub> composites was noticeably smaller than that for other zirconia ceramics.

TABLE II Characteristic of the solvents,  $\sigma_v^*$ ,  $\sigma_d^*$  and  $\Delta T_c$  of 3Y-TZP and Al<sub>2</sub>O<sub>3</sub> in various quenching media

	Methyl alcohol	Glycerin	Water	
$\overline{k (W m^{-1} K^{-1})}$	0.216	0.285	0.574	
$c \times 10^{-3} (\mathrm{J  kg^{-1}  K^{-1}})$	2.51	2.39	4.20	
$\varrho \times 10^3  (\mathrm{kg}\mathrm{m}^{-3})$	0.792	1,26	1.00	
$\mu \times 10^6 (\mathrm{kg}\mathrm{m}^{-1}\mathrm{sec}^{-1})$	0.59	1500	1.79	
$B \times 10^{6} ({\rm K}^{-1})$	1700	610	53	
$\sigma_v^*$ (3Y-TZP)	0.167	0.035	0.189	
$\sigma_d^*$ (3Y-TZP)	0.180	0.236	0.341	
$\Delta T_{c}$ (3Y-TZP)	350	475	275	
$\sigma_{\nu}^{*}$ (Al <sub>2</sub> O <sub>3</sub> )	0.017	0.003	0.020	
$\sigma_4^*$ (Al <sub>2</sub> O <sub>3</sub> )	0.069	0.095	0.150	
$\Delta T_{\rm c}$ (Al <sub>2</sub> O <sub>3</sub> )	350	325	200	

 $r_{\rm m} = 2\,\rm mm$ 

Since  $k/r_m h$  is positive, Equation 8 can be derived from Equations 2 and 3.

$$\Delta T_{\rm c} > 1.451\sigma_{\rm t}(1-\nu)/\alpha E \tag{8}$$

The plot of observed  $\Delta T_c$  against  $1.451\sigma_t(1 - \nu)/\alpha E$  is shown in Fig. 5, where  $\sigma_t$  is calculated from Equation 6 using the *m* of 10. The slope of the dashed line is 1. As expected by Equation 8, the plots of  $\Delta T_c$  in Ce-TZP, Mg-PSZ, 6Y-CSZ, Al<sub>2</sub>O<sub>3</sub>, mullite, SiC and Si<sub>3</sub>N<sub>4</sub> located above the dashed line, but those of Y-TZP based ceramics such as 3Y-TZP, 2Y-TZP and 2Y-TZP/Al<sub>2</sub>O<sub>3</sub> composites were below the dash line.

The heat transfer coefficient, h, calculated by Equations 2 and 3 using the results listed in Table III for Al<sub>2</sub>O<sub>3</sub>, mullite, SiC, Si<sub>3</sub>N<sub>4</sub>, Mg-PSZ, 6Y-CSZ and Ce-TZP is shown in Fig. 6 as a function of  $\Delta T_c$ . The value of h for natural convection calculated by Equation 5 was 1910 W m<sup>-2</sup> K<sup>-1</sup> (log h = 3.28). The large value of h in Fig. 6 may be influenced by boiling of the solvents. By assuming the value of  $h = 1.0 \times 10^4$  W m<sup>-2</sup> K<sup>-1</sup>, the thermal fracture stresses of



Figure 5 Relation between  $\Delta T_c$  and thermal shock resistance parameter,  $1.451\sigma_t(1 - \nu)/\alpha E$ .

TABLE III Bending strength and critical temperature difference of various ceramics quenched into water at  $0^{\circ}$  C

Material	$\sigma_{3b}^{r}(MPa)$	$\sigma_{3b}^{h}(MPa)$	$\Delta T_{\rm c}(^{\circ}{\rm C})$
Al <sub>2</sub> O <sub>3</sub>	300		225
Si <sub>3</sub> N₄	500		750
SiC	330		425
Mg-PSZ	460	353	300
6Y-CSZ	240		200
3Y-TZP	900	700	275
2Y-TZP	1300	900	250
2Y-TZP/10 wt % Al <sub>2</sub> O <sub>3</sub>	1720	1200	250
2Y-TZP/20 wt % Al <sub>2</sub> O <sub>3</sub>	2060	1300	300
2Y-TZP/40 wt % Al <sub>2</sub> O <sub>3</sub>	2070	1450	325
8Ce-TZP	600	439*	360
12Ce-TZP	425	311*	290
16Ce-TZP	160	117*	260

\*Estimated

3Y-TZP, 2Y-TZP, 2Y-TZP/Al<sub>2</sub>O<sub>3</sub> composites calculated by Equations 1 and 3 were 235–285 MPa. These values were significantly smaller than the fracture strength determined by the bending test. These peculiar results for Y-TZP based ceramics were agreed with the results reported by Ashizuka *et al.* [11].

The present results indicate that the cracks which caused strength degradation in Y-TZP based ceramics were propagated by the thermal stress without the tetragonal to monoclinic phase transformation being smaller than the original fracture stress, because no phase transformation was observed on the surface of the sample quenched from various temperatures into water. Therefore, it seems that the stress-induced phase transformation mechanism does not sufficiently function against thermal stress. However, the detailed mechanism of rapid crack growth without phase transformation in Y-TZP is not clear yet.

#### 4. Conclusion

1. Thermal shock fracture under present experimental conditions was initiated by the thermal stress due to convective heat transfer accompanied by boiling of the solvents.

2.  $\Delta T_{\rm c}$  of zirconia based ceramics increased linearly with increasing  $\sigma_{3b}$ , but the thermal shock resistance of Y-TZP based ceramics was anormalously lower than the predicted value.

3. The cracks in Y-TZP based ceramics were propagated by the thermal stress being smaller than the original fracture stress.

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Figure 6 Values of heat transfer coefficient of various ceramics at critical temperature difference.

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